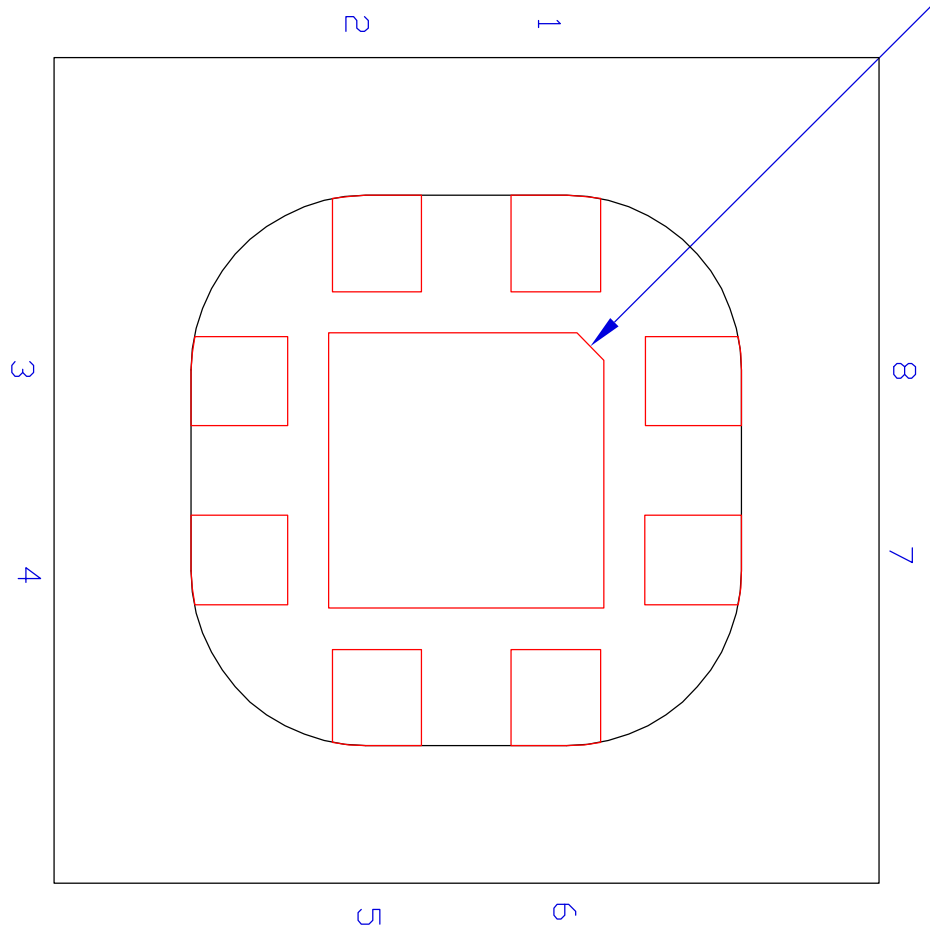




PIN 1 INDICATOR



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|   |   |  |    |          |  |   |  |  |  |
|---|---|--|----|----------|--|---|--|--|--|
| TOLERANCES UNLESS NOTED:  |   | APPROVALS  |    | DATE     |  | <br><b>Mirror</b><br>Semiconductor™<br>TITLE A-QFN 8-LEAD 3MM BONDING DIAGRAM<br>SCALE NONE SIZE A DRAWING NO. 460814 REV A<br>DO NOT SCALE DRAWING SHEET 1 OF 1 |  |  |  |
| X.XX  | ± | DRAWN  | TA | 11/29/08 |  |   |  |  |  |
| X.XXX   | ± | ENG  |    |          |  |   |  |  |  |
| X.XXXX  | ± | MFG  |    |          |  |   |  |  |  |
| ALL DIMENSIONS ARE IN: <input type="checkbox"/> INCHES <input type="checkbox"/> MILLIMETERS |   | THIRD ANGLE PROJECTION:  |    |          |  |   |  |  |  |
|   |   |  |    |          |  |   |  |  |  |
|   |   | REVISED  |    |          |  |   |  |  |  |